SDAS142C - JULY 1987 - REVISED AUGUST 1995

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

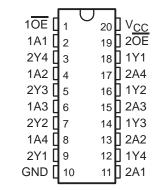
description

These octal buffers and line drivers are designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. With the 'ALS240A, 'ALS241C, 'AS240A, and 'AS241A, these devices provide the choice of selected combinations of inverting outputs, symmetrical active-low output-enable (OE) inputs, and complementary OE and OE inputs.

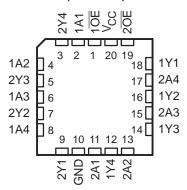
The -1 version of SN74ALS244C is identical to the standard version, except that the recommended maximum I_{OL} for the -1 version is 48 mA. There is no -1 version of the SN54ALS244C.

The SN54ALS244C and SN54AS244A are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS244C and SN74AS244A are characterized for operation from 0°C to 70°C.

SN54ALS244C, SN54AS244A . . . J PACKAGE SN74ALS244C, SN74AS244A . . . DW OR N PACKAGE (TOP VIEW)



SN54ALS244C, SN54AS244A . . . FK PACKAGE (TOP VIEW)



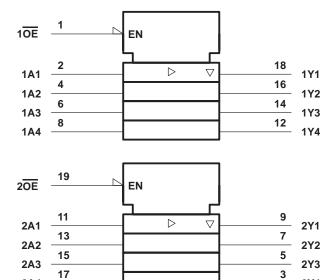
FUNCTION TABLE (each buffer)

| INPU | JTS | OUTPUT |
|------|-----|--------|
| OE | Α | Y |
| L | Н | Н |
| L | L | L |
| Н | Χ | Z |

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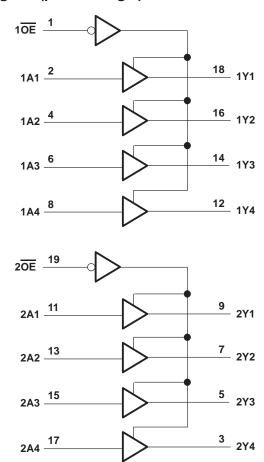
logic symbol[†]

2A4



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

2Y4

| Supply voltage, V _{CC} | 7 V |
|--|----------------|
| Input voltage, V _I | 7 V |
| Voltage applied to a disabled 3-state output | 5.5 V |
| Operating free-air temperature range, T _A : SN54ALS244C | 55°C to 125°C |
| SN74ALS244C | 0°C to 70°C |
| Storage temperature range | −65°C to 150°C |

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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recommended operating conditions

| | | SNS | 54ALS24 | 4C | SN7 | '4ALS24 | 4C | UNIT |
|-----|--------------------------------|-----|---------|------|-----|---------|-----|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNII |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| \/ | Low level input veltage | | | 0.8† | | | 0.8 | V |
| VIL | Low-level input voltage | | | 0.7‡ | | | | V |
| lOH | High-level output current | | | -12 | | | -15 | mA |
| la. | Low-level output current | | | 12 | | | 24 | mA |
| IOL | Low-level output current | | | | | | 48§ | IIIA |
| TA | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

[†] Applies over temperature range –55°C to 70°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST (| CONDITIONS | SNS | 4ALS24 | 4C | SN7 | 4ALS24 | 4C | UNIT |
|-----------------|----------------------------------|--------------------------------------|--------------------|--------|------|--------|--------|------|------|
| PARAMETER | lE31 C | CONDITIONS | MIN | TYP¶ | MAX | MIN | TYP¶ | MAX | UNII |
| VIK | $V_{CC} = 4.5 \text{ V},$ | $I_{I} = -18 \text{ mA}$ | | | -1.5 | | | -1.5 | V |
| | V _{CC} = 4.5 V to 5.5 V | $I_{OH} = -0.4 \text{ mA}$ | V _{CC} -2 | 2 | | VCC -2 | 2 | | |
| Vari | VCC = 4.5 V to 5.5 V | $I_{OH} = -3 \text{ mA}$ | 2.4 | 3.2 | | 2.4 | 3.2 | | V |
| VOH | V _{CC} = 4.5 V | $I_{OH} = -12 \text{ mA}$ | 2 | | | | | | v |
| | vCC = 4.5 v | $I_{OH} = -15 \text{ mA}$ | | | | 2 | | | |
| | | I _{OL} = 12 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | |
| VOL | $V_{CC} = 4.5 \text{ V}$ | I _{OL} = 24 mA | | | | | 0.35 | 0.5 | V |
| | | I _{OL} = 48 mA (-1 version) | | | | | 0.35 | 0.5 | |
| lozh | $V_{CC} = 5.5 \text{ V},$ | V _O = 2.7 V | | | 20 | | | 20 | μΑ |
| lozL | $V_{CC} = 5.5 \text{ V},$ | V _O = 0.4 V | | | -20 | | | -20 | μΑ |
| lj | $V_{CC} = 5.5 \text{ V},$ | $V_I = 7 V$ | | | 0.1 | | | 0.1 | mA |
| lіН | $V_{CC} = 5.5 V,$ | V _I = 2.7 V | | | 20 | | | 20 | μΑ |
| I _{IL} | V _{CC} = 5.5 V, | V _I = 0.4 V | | | -0.1 | | | -0.1 | mA |
| IO [#] | V _{CC} = 5.5 V, | V _O = 2.25 V | -20 | | -112 | -30 | | -112 | mA |
| | | Outputs high | | 9 | 18 | | 9 | 17 | |
| ICC | V _{CC} = 5.5 V | Outputs low | | 15 | 25 | | 15 | 24 | mA |
| | | Outputs disabled | | 17 | 29 | | 17 | 27 | |



[‡] Applies over temperature range 70°C to 125°C

[§] Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

[¶] All typical values are at V_{CC} = 5 V, T_A = 25°C.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

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switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | C _L R1 R2 | = 50 pF = 500 £ 2 = 500 £ | 2, | , | UNIT |
|------------------|-----------------|----------------|----------------------------|---------------------------------|--------|-------|------|
| | | | SN54AL | S244C | SN74AL | S244C | |
| | | | MIN | MAX | MIN | MAX | |
| t _{PLH} | А | Y | 1 | 16 | 2 | 10 | ns |
| t _{PHL} | Α | Y | 3 | 12 | 3 | 10 | 115 |
| ^t PZH | ŌĒ | Y | 1 | 26 | 3 | 20 | ns |
| tPZL | OE | Y | 1 | 24 | 3 | 20 | 115 |
| ^t PHZ | ŌĒ | V | 2 | 10 | 2 | 10 | ns |
| ^t PLZ | OL . | ' | 1 | 26 | 1 | 13 | 115 |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| Supply voltage, V _{CC} | 7 V |
|---|----------------|
| Input voltage, V _I | 7 V |
| Voltage applied to a disabled 3-state output | 5.5 V |
| Operating free-air temperature range, T _A : SN54AS244A | −55°C to 125°C |
| SN74AS244A | 0°C to 70°C |
| Storage temperature range | -65°C to 150°C |

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

| | | SN | 54AS244 | 1A | SN | 74AS24 | 4A | UNIT |
|----------|--------------------------------|-----|---------|-----|-----|--------|-----|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNII |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| ІОН | High-level output current | | | -12 | | | -15 | mA |
| loL | Low-level output current | | | 48 | | | 64 | mA |
| TA | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED | TEST O | ONDITIONS | SN | 54AS24 | 4A | SN | 74AS24 | 4A | LINUT |
|-----------------|---|---------------------------|--------------------|------------------|------|--------------------|--------|------|-------|
| PARAMETER | IESI C | ONDITIONS | MIN | TYP [†] | MAX | MIN | TYP† | MAX | UNIT |
| VIK | V _{CC} = 4.5 V, | I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ | $I_{OH} = -2 \text{ mA}$ | V _{CC} -2 | 2 | | V _{CC} -2 | | | |
| Va | | $I_{OH} = -3 \text{ mA}$ | 2.4 | 3.4 | | 2.4 | 3.4 | | V |
| VOH | V _{CC} = 4.5 V | $I_{OH} = -12 \text{ mA}$ | 2.4 | | | | | | V |
| | | $I_{OH} = -15 \text{ mA}$ | | | | 2.4 | | | |
| Va | V _{CC} = 4.5 V | I _{OL} = 48 mA | | | 0.55 | | | | V |
| VOL | VCC = 4.5 V | I _{OL} = 64 mA | | | | | | 0.55 | V |
| lozh | $V_{CC} = 5.5 V,$ | V _O = 2.7 V | | | 50 | | | 50 | μΑ |
| lozL | $V_{CC} = 5.5 V,$ | V _O = 0.4 V | | | -50 | | | -50 | μΑ |
| Ц | $V_{CC} = 5.5 V,$ | V _I = 7 V | | | 0.1 | | | 0.1 | mA |
| lін | $V_{CC} = 5.5 V,$ | V _I = 2.7 V | | | 20 | | | 20 | μΑ |
| OE OE | V00 - 5 5 V | V _I = 0.4 V | | | -0.5 | | | -0.5 | mA |
| IIL A | V _{CC} = 5.5 V, | V = 0.4 V | | | -1 | | | -1 | ША |
| 10 [‡] | $V_{CC} = 5.5 V,$ | V _O = 2.25 V | -50 | | -150 | -50 | | -150 | mA |
| | | Outputs high | | 22 | 34 | | 22 | 34 | |
| ICC | V _{CC} = 5.5 V | Outputs low | | 60 | 90 | | 60 | 90 | mA |
| | | Outputs disabled | | 34 | 54 | | 34 | 54 | |

switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) TO (OUTPUT) TO (OUTPUT) TA = I SN54AS244 MIN MA A Y 1 1 1 | L = 50 1 = 500 2 = 500 A = MIN | Ω, | § | UNIT | | |
|------------------|--|---|----|------|------|-----|-----|
| | | | | MAX | MIN | MAX | |
| ^t PLH | Δ | ., | 2 | 9 | 2 | 6.2 | |
| ^t PHL | А | Y | 1 | 7 | 1 | 6.2 | ns |
| ^t PZH | <u></u> | V | 1 | 10 | 1 | 9 | ns |
| t _{PZL} | ÜE | Y | 2 | 8 | 2 | 7.5 | 115 |
| ^t PHZ | ŌĒ | ٧ | 1 | 6.5 | 1 | 6 | ns |
| tPLZ | OL . | ľ | 1 | 10.5 | 1 | 9 | 113 |

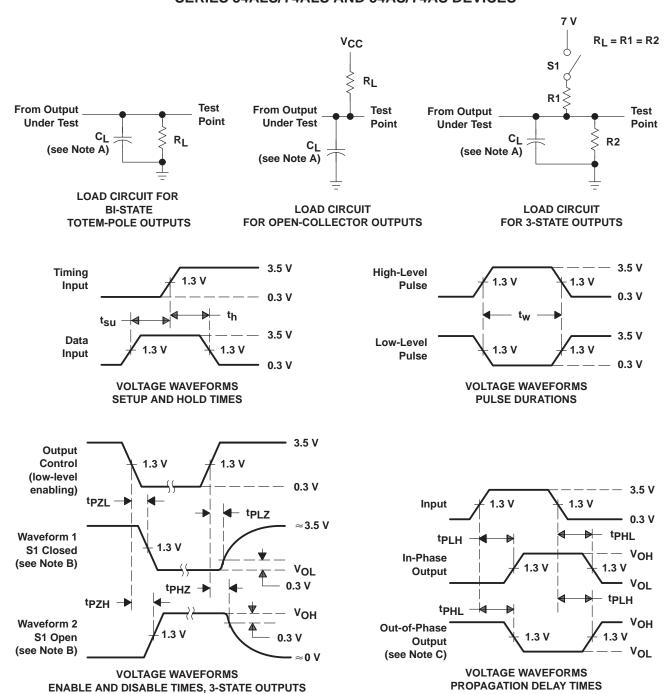
[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







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PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead/Ball Finish (6) | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------|----------------------|--------------------|--------------|--|---------|
| 5962-86839012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962- 86839012A SNJ54ALS 244CFK | Samples |
| 5962-8683901RA | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-8683901RA SNJ54ALS244CJ | Samples |
| 5962-8683901SA | ACTIVE | CFP | W | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-8683901SA SNJ54ALS244CW | Samples |
| 5962-8683901VRA | ACTIVE | CDIP | J | 20 | 20 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-8683901VR A SNV54ALS244CJ | Samples |
| 5962-8683901VSA | ACTIVE | CFP | W | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-8683901VS A SNV54ALS244CW | Samples |
| 5962-9755901Q2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962- 9755901Q2A SNJ54AS 244AFK | Samples |
| 5962-9755901QRA | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-9755901QR A SNJ54AS244AJ | Samples |
| 5962-9755901QSA | ACTIVE | CFP | W | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-9755901QS A SNJ54AS244AW | Samples |
| JM38510/38303B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | JM38510/ 38303B2A | Samples |
| JM38510/38303BRA | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | JM38510/ 38303BRA | Samples |
| M38510/38303B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | JM38510/ 38303B2A | Samples |
| M38510/38303BRA | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | JM38510/ 38303BRA | Samples |
| SN54ALS244CJ | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | SN54ALS244CJ | Samples |
| SN54AS244AJ | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | SN54AS244AJ | Samples |





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| Orderable Device | Status | Package Type | _ | Pins | Package | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|--------------------|----------|--------------|---------|------|---------|----------------------------|------------------|--------------------|--------------|-----------------------|---------|
| | (1) | | Drawing | | Qty | (2) | (6) | (3) | | (4/5) | |
| SN74ALS244C-1DW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C-1 | Samples |
| SN74ALS244C-1DWR | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C-1 | Samples |
| SN74ALS244C-1N | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS244C-1N | Samples |
| SN74ALS244C-1NSR | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C-1 | Samples |
| SN74ALS244C-1NSRG4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C-1 | Samples |
| SN74ALS244CDBLE | OBSOLETI | SSOP | DB | 20 | | TBD | Call TI | Call TI | 0 to 70 | | |
| SN74ALS244CDBR | ACTIVE | SSOP | DB | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | G244C | Samples |
| SN74ALS244CDBRG4 | ACTIVE | SSOP | DB | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | G244C | Samples |
| SN74ALS244CDW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C | Samples |
| SN74ALS244CDWR | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C | Samples |
| SN74ALS244CDWRE4 | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C | Samples |
| SN74ALS244CDWRG4 | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C | Samples |
| SN74ALS244CN | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS244CN | Samples |
| SN74ALS244CNE4 | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS244CN | Samples |
| SN74ALS244CNSR | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C | Samples |
| SN74ALS244CNSRG4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS244C | Samples |
| SN74AS244ADW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | AS244A | Samples |
| SN74AS244ADWR | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | AS244A | Samples |





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| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|--|---------|
| SN74AS244AN | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74AS244AN | Samples |
| SN74AS244ANE4 | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74AS244AN | Samples |
| SN74AS244ANSR | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74AS244A | Samples |
| SNJ54ALS244CFK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962- 86839012A SNJ54ALS 244CFK | Samples |
| SNJ54ALS244CJ | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-8683901RA SNJ54ALS244CJ | Samples |
| SNJ54ALS244CW | ACTIVE | CFP | W | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-8683901SA SNJ54ALS244CW | Samples |
| SNJ54AS244AFK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962- 9755901Q2A SNJ54AS 244AFK | Samples |
| SNJ54AS244AJ | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-9755901QR A SNJ54AS244AJ | Samples |
| SNJ54AS244AW | ACTIVE | CFP | W | 20 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | 5962-9755901QS A SNJ54AS244AW | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

PACKAGE OPTION ADDENDUM



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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54ALS244C. SN54ALS244C-SP. SN54AS244A. SN74ALS244C. SN74AS244A :

Catalog: SN74ALS244C, SN54ALS244C, SN74AS244A

Military: SN54ALS244C, SN54AS244A

Space: SN54ALS244C-SP

NOTE: Qualified Version Definitions:

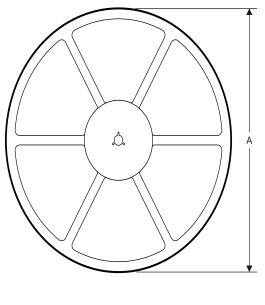
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

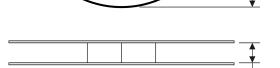
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION

REEL DIMENSIONS





TAPE DIMENSIONS



| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

TAPE AND REEL INFORMATION

*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ALS244C-1DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.0 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74ALS244C-1NSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.2 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |
| SN74ALS244CDBR | SSOP | DB | 20 | 2000 | 330.0 | 16.4 | 8.2 | 7.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74ALS244CDWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.0 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74ALS244CNSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.2 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |
| SN74AS244ADWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.0 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74AS244ANSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.2 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ALS244C-1DWR | SOIC | DW | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS244C-1NSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS244CDBR | SSOP | DB | 20 | 2000 | 367.0 | 367.0 | 38.0 |
| SN74ALS244CDWR | SOIC | DW | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS244CNSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74AS244ADWR | SOIC | DW | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74AS244ANSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.

 D. Index point is provided on cap for terminal identification only.

 E. Falls within Mil—Std 1835 GDFP2—F20



FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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